JJMICROELECTRONICS

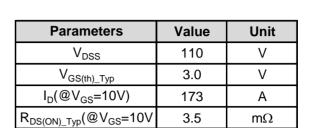
110V, 173A, 3.5mΩ N-channel Power SGT MOSFET JMSH1103TE

Features

- Excellent $\mathsf{R}_{\mathsf{DS}(\mathsf{ON})}$ and Low Gate Charge
- 100% UIS TESTED
- 100% ΔVds TESTED
- Halogen-free; RoHS-compliant
- Pb-free plating

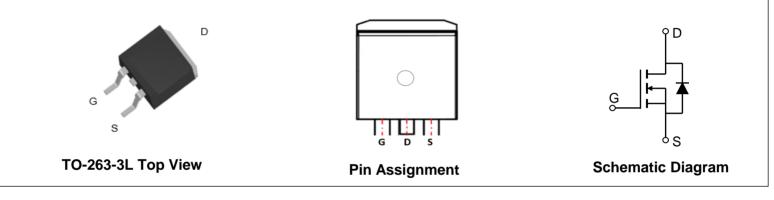
Applications

- Load Switch
- PWM Application
- Power Management





Product Summary



Ordering Information

Device	Marking	MSL	Form	Package	Reel(pcs)	Per Carton (pcs)	
JMSH1103TE	SH1103T	3	Tape&Reel	TO-263-3L	800	4000	

Absolute Maximum Ratings (@ T_c = 25°C unless otherwise specified)

Symbol	Parameter		Value	Unit
V _{DS}	Drain-to-Source Voltage		110	V
V _{GS}	Gate-to-Source Voltage		±20	V
1	Continuous Drain Current	$T_C = 25^{\circ}C$	173	A
ID	Continuous Drain Current	$T_{\rm C} = 100^{\circ}{\rm C}$	122	
I _{DM}	Pulsed Drain Current ⁽¹⁾		Refer to Fig.4	A
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		820	mJ
P _D	Power Dissinction	T _C = 25°C	325	w
ГD	Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$	130	vv
T _J , T _{STG}	Junction & Storage Temperature Range		-55 to 150	C°

Thermal Characteristics

Symbol	Parameter	Мах	Unit
R_{\thetaJA}	Thermal Resistance, Junction to Ambient ⁽³⁾	70	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.4	C/ VV

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	iracteristics				ļ	ļ
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0V$	110	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 88V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics			•	1	•
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.1	3.0	3.8	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 20A$	-	3.5	4.5	mΩ
Dynami	c Characteristics					
R_{g}	Gate Resistance	f = 1MHz	-	2.2	-	Ω
C _{iss}	Input Capacitance		-	5718	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 55V,$ f = 1MHz	-	816	-	pF
C_{rss}	Reverse Transfer Capacitance		-	27	-	pF
Q_g	Total Gate Charge	N/ 0/ /0//	-	86	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 55V, I_D = 20A$	-	30	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 00 V, I <u>D</u> = 20/V	-	19	-	nC
Switchi	ng Characteristics					
t _{d(on)}	Turn-On DelayTime		-	25	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 55V	-	41	-	ns
t _{d(off)}	Turn-Off DelayTime	I_{D} = 20A, R_{GEN} = 6.2 Ω	-	67	-	ns
t _f	Turn-Off Fall Time		-	42	-	ns
Body D	iode Characteristics					
I _S	Maximum Continuous Body Diode Forward Current		-	-	173	А
I_{SM}	Maximum Pulsed Body Diode Forward Current		-	-	691	А
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	L = 200 di/dt 1000 /va	-	82	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 20A, di/dt = 100A/us	-	223	-	nC

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

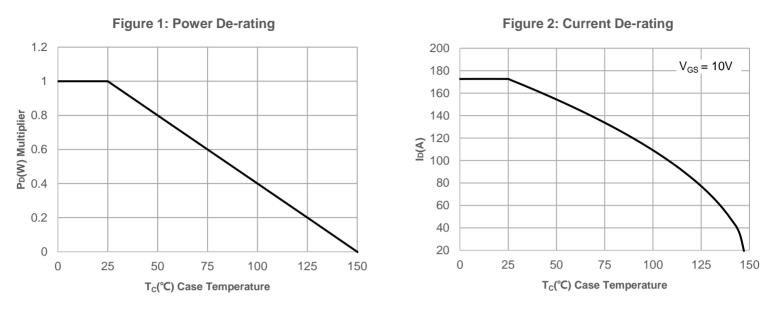
2. E_{AS} condition: Starting T_J =25C, V_{DD} =55V, V_G =10V, R_G =25ohm, L=3mH, I_{AS} =23.38A, V_{DD} =0V during time in avalanche.

3. $R_{\theta JA}$ is measured with the device mounted on a 1inch 2 pad of 2oz copper FR4 PCB.

4. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 0.5%.

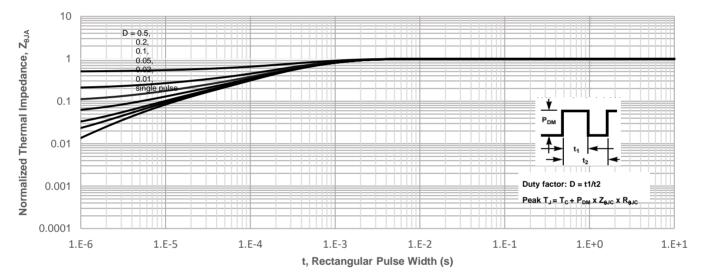




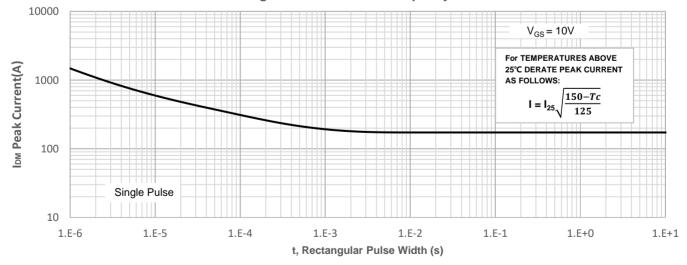


Typical Performance Characteristics

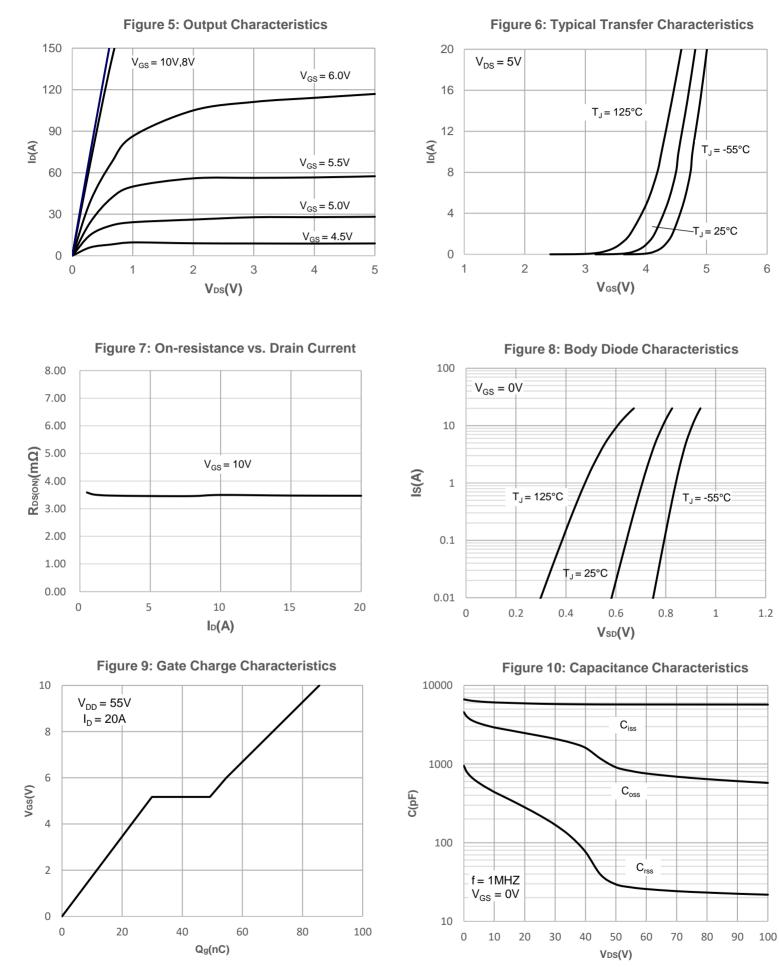










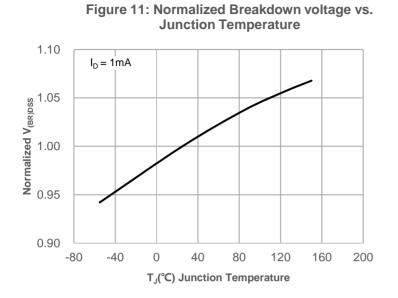


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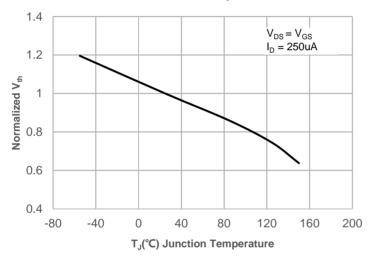
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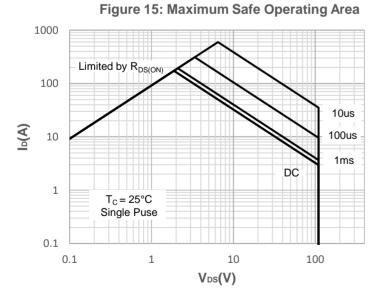


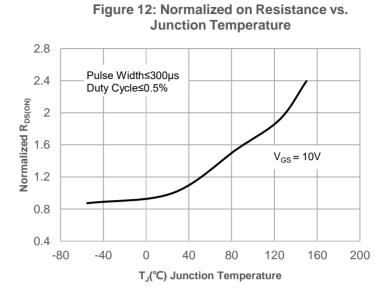
Typical Performance Characteristics

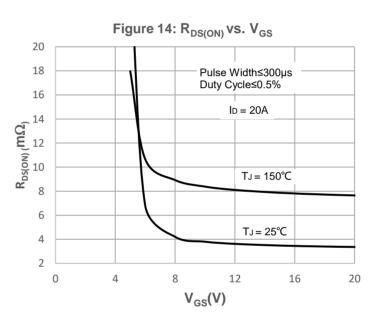












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Test Circuit

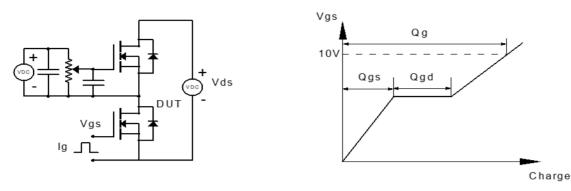


Figure 1: Gate Charge Test Circuit & Waveform

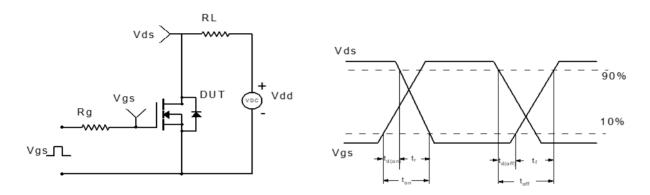


Figure 2: Resistive Switching Test Circuit & Waveform

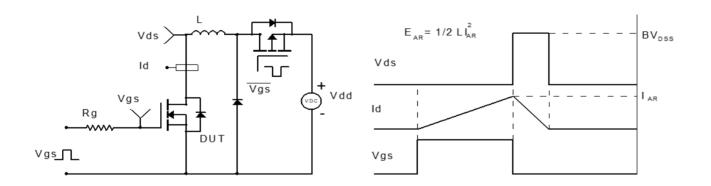


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

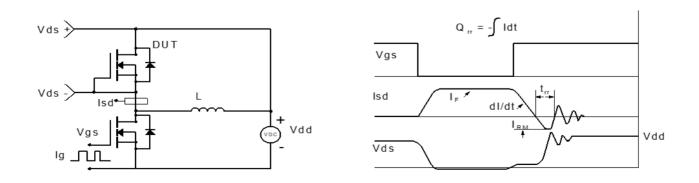


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-263-3L)

	Ref.	Millimeters		Inches			
		Min.	Тур.	Max.	Min.	Тур.	Max.
	Α	9.90		10.20	0.390		0.402
	В	14.70		15.80	0.579		0.622
	С	9.4		9.6	0.37		0.378
	D		2.54			0.100	
	E	1.20		1.40	0.047		0.055
	F	0.75		0.85	0.029		0.033
	G			1.75			0.069
	н	4.40		4.70	0.173		0.185
	J	2.30		2.70	0.091		0.106
K	к	0.38		0.55	0.015		0.022
D.	L	0	0.10	0.25	0	0.004	0.010
TO-263	М	1.25		1.35	0.049		0.053

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